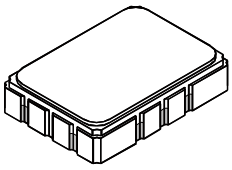
SF2040B-3

80.460 MHz
SAW Filter

- ***Designed for SDARS IF Receiver***
- ***Low Insertion Loss***
- ***5.0 X 7.0 mm Surface-Mount Case***
- ***Differential or Single Ended Input and Output***
- ***Complies with Directive 2002/95/EC (RoHS)***



SMP-03-S

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	265°C for 10 s	

Electrical Characteristics

Characteristic		Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency		f_C	1		80.460		MHz
Passband	Insertion Loss	IL			9.5	12.0	dB
	1dB Passband	BW_1	1	3.7	4.1		MHz
	15dB Bandwidth	BW_{15}			6.6	6.7	MHz
	30dB Bandwidth	BW_{30}			7.6	7.7	MHz
	Amplitude Ripple over fc ±1.85 MHz				0.5	1.1	dB_{P-P}
	Group Delay Variation over fc ±1.85 MHz	GDV			60	150	ns_{P-P}
Rejection	50 to 74.39 MHz		1, 3	40	44		dB
	74.39 to 75.99 MHz			34	40		
	85.21 to 86.65 MHz			37	44		
	86.65 to 91.50 MHz			40	48		
	91.50 to 95.21 MHz			44	53		
	95.21 to 100 MHz			45	53		
Operating Temperature Range		T_A	1	-40		+85	°C
Frequency Temperature Coefficient		FTC			-18		ppm/°C
Differential Input				175 ohms			
Differential Output				1000 ohms			
Case Style			6	SMP-03-S 5 x 7 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift) See note 4				RFM SF2040B-3 YYWWS			

Electrical Connections

Connection	Port 1 Hot	Port 1 Ground Return or Hot	Port 2 Hot	Port 2 Ground Return or Hot	Case Ground
Terminals	10	1	5	6	All Others

Notes:
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
10. ©Copyright 1999, RF Monolithics Inc.
11. Electrostatic Sensitive Device. Observe precautions for handling.

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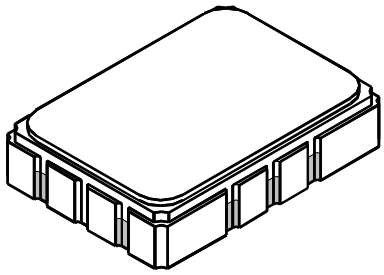
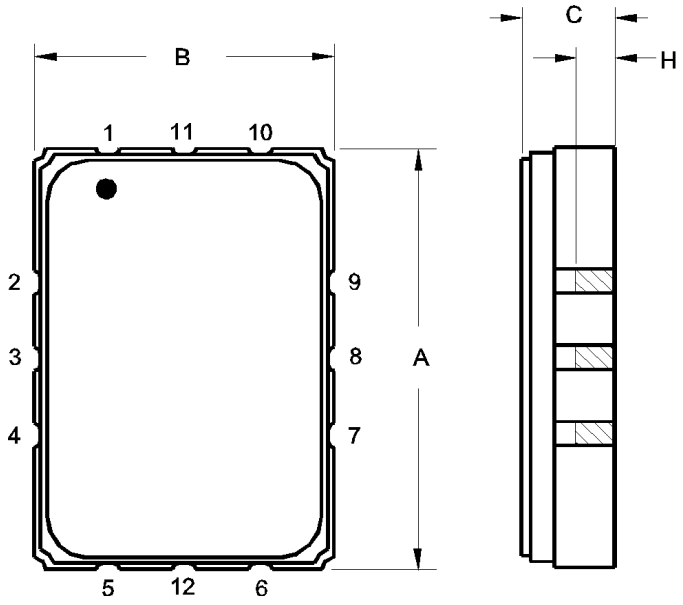
SMP-03-S Case

12-Terminal Ceramic Surface-Mount Case
5 x 7 mm Nominal Footprint

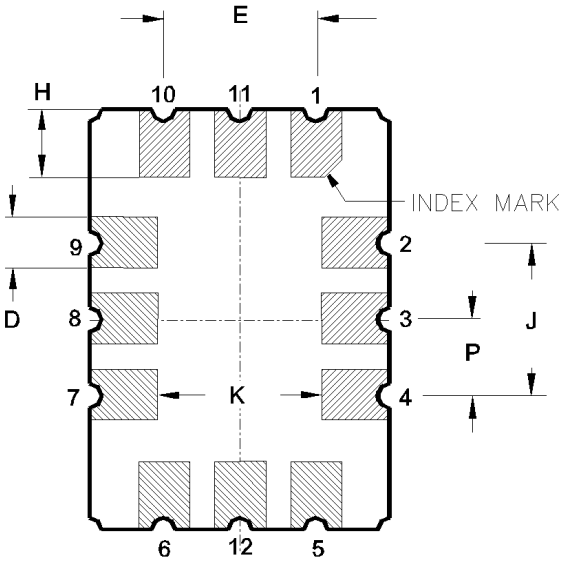


Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D		0.80				
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.1	1.13	0.034	0.039	0.044
J		2.54				
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

Materials	
Solder Pad Termination	Au plating 30 - 60 µinches (76.2-152 µm) over 80-200 µinches (203-508 µm) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick
Body	Al_2O_3 Ceramic
Pb Free	

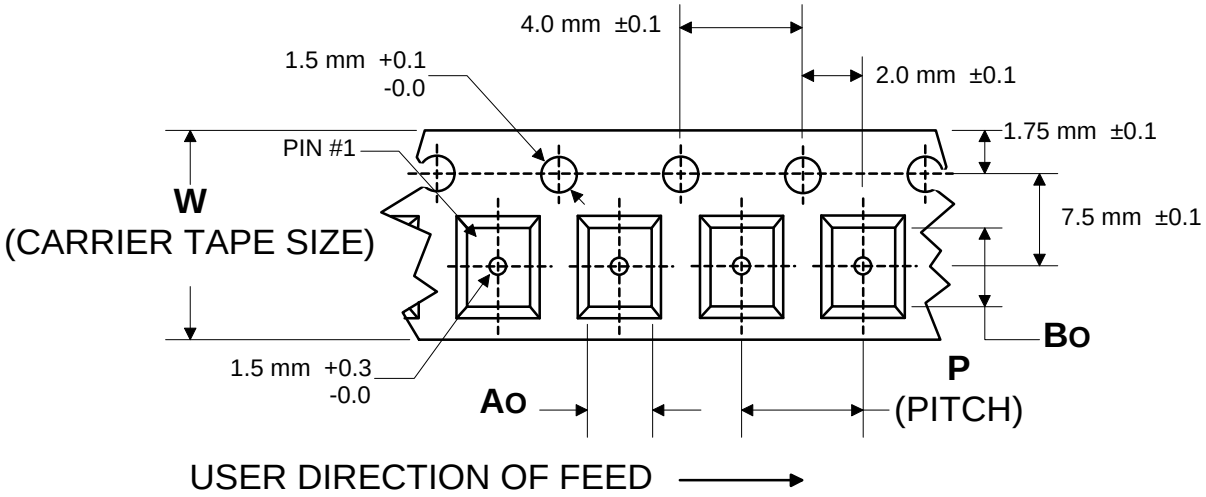


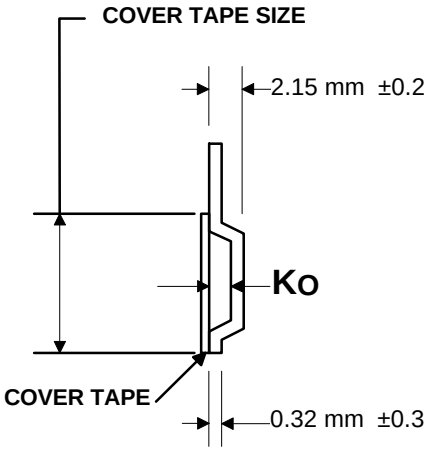
TOP VIEW



BOTTOM VIEW

COMPONENT ORIENTATION and DIMENSIONS





Carrier Tape Dimensions		
Ao	5.5 mm	±0.1
Bo	7.5 mm	±0.1
Ko	2.0 mm	±0.1
Pitch	8.0 mm	±0.1
W	16.0 mm	±0.3